

# **Pin Descriptions**

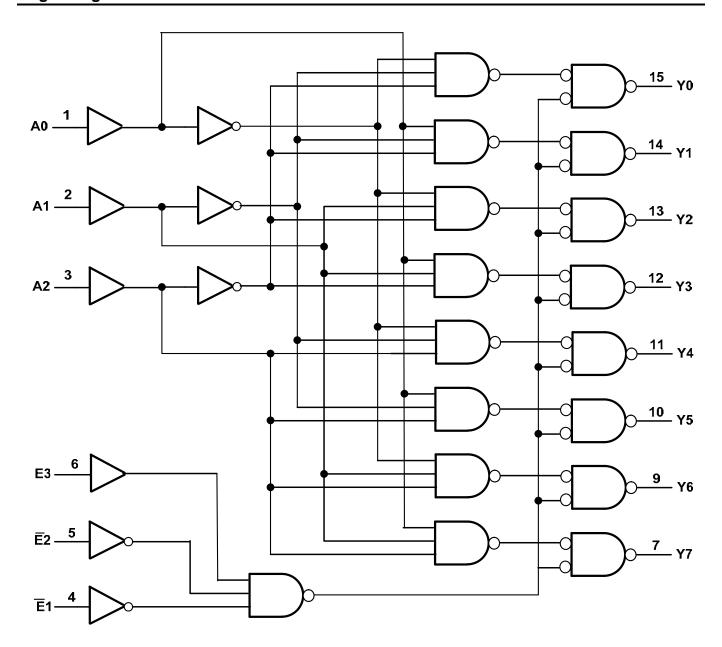
Pin Number	Pin Name	Description
1	A0	Address Input 0
2	A1	Address Input 1
3	A2	Address Input 2
4	E <sub>1</sub>	Enable Input 1 (active LOW)
5	E2	Enable Input 2 (active LOW)
6	E3	Enable Input 3 (active HIGH)
7	Y7	Output 7 (active LOW)
8	GND	Ground
9	Y6	Output 6 (active LOW)
10	Y5	Output 5 (active LOW)
11	Y4	Output 4 (active LOW)
12	Y3	Output 3 (active LOW)
13	Y2	Output 2 (active LOW)
14	Y1	Output 1 (active LOW)
15	Y0	Output o (active LOW)
16	Vcc	Supply Voltage

# Function Table Diagram

	Control			Input					(	Output			
E <sub>1</sub>	E2	E3	A2	A1	A0	<del>7</del> 7	<del>Y</del> 6	<del>Y</del> 5	<del>Y</del> 4	<del>7</del> 3	<del>Y</del> 2	<u>Y</u> 1	<u>₹</u> 0
Н	Х	Х	Х	Х	Х	Н	Н	Н	Н	Н	Н	Н	Н
Х	Н	Х	-	-	_	-	_	_	_	-	-	_	-
Х	Х	L	-	-	_	_	_	_	_	-	-	_	-
L	L	Н	_	_	_	_	_	_	_	_	_	_	-
-	_	_	L	L	L	Н	Н	Н	Н	Н	Н	Н	L
-	_	_	L	L	Н	Н	Н	Н	Н	Н	Н	L	Н
-	_	_	L	Н	L	Н	Н	Н	Н	Н	L	Н	Н
-	_	_	L	Н	Н	Н	Н	Н	Н	L	Н	Н	Н
_	_	_	Н	L	L	Н	Н	Н	L	Н	Н	Н	Н
-	_	_	Н	L	Н	Н	Н	L	Н	Н	Н	Н	Н
-	_	_	Н	Н	L	Н	L	Н	Н	Н	Н	Н	Н
_	-	-	Н	Н	Н	L	Н	Н	Н	Н	Н	Н	Н



# **Logic Diagram**



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# **Absolute Maximum Ratings** (Note 4) (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Symbol	Description	Rating	Unit
ESD HBM	Human Body Model ESD Protection	2	kV
ESD CDM	Charged Device Model ESD Protection	1	kV
ESD MM	Machine Model ESD Protection	200	V
$V_{CC}$	Supply Voltage Range	-0.5 to +7.0	V
VI	Input Voltage Range	-0.5 to +7.0	V
Vo	Voltage applied to output in high or low state	-0.3 to V <sub>CC</sub> +0.5	V
I <sub>IK</sub>	Input Clamp Current V <sub>I</sub> < -0.5V	-20	mA
I <sub>IK</sub>	Input Clamp Current VI > V <sub>CC</sub> +0.5V	20	mA
I <sub>OK</sub>	Output Clamp Current Vo<-0.5V	-20	mA
lok	Output Clamp Current V <sub>O</sub> > V <sub>CC</sub> + 0.5V	20	mA
lo	Continuous output current	±25	mA
Icc	Continuous current through V <sub>CC</sub>	50	mA
I <sub>GND</sub>	Continuous current through GND	-50	mA
TJ	Operating Junction Temperature	-40 to +150	°C
T <sub>STG</sub>	Storage Temperature	-65 to +150	°C
Ртот	Total Power Dissipation	500	mW

Note:

# Recommended Operating Conditions (Note 5) (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Symbol	Parameter	Conditions	Min	Max	Unit
V <sub>CC</sub>	Supply Voltage	_	2.0	6.0	V
$V_{I}$	Input Voltage	_	0	$V_{CC}$	V
Vo	Output Voltage	Active Mode	0	Vcc	V
		V <sub>CC</sub> = 2.0V		1000	ns/V
Δt/ΔV	Input transition Rise or Fall Rate	V <sub>CC</sub> = 4.5V	-	500	115/ V
		V <sub>CC</sub> = 6.0V	-	400	-
TA	Operating Free-Air Temperature	_	-40	+125	°C

Note:

5. Unused inputs should be held at  $V_{\text{CC}}$  or Ground.

<sup>4.</sup> Stresses beyond the absolute maximum may result in immediate failure or reduced reliability. These are stress values and device operation should be within recommend values.



## **Electrical Characteristics** (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Symbol	Parameter	Test Conditions	V	T <sub>A</sub>	= +25°C		$T_A = -40$ °C	to +85°C	T <sub>A</sub> = -40°	C to +125°C	Unit	
Oymboi i arameter	rest Conditions	V <sub>CC</sub>	Min	Тур	Max	Min	Max	Min	Max	Unit		
		-	2.0V	1.5	1.2	_	1.5	-	1.5	-		
$V_{IH}$	High-Level Input Voltage	-	4.5V	3.15	2.4	_	3.15	-	3.15	-	V	
	input voltage	-	6.0V	4.2	3.2	_	4.2	-	4.2	-		
		-	2.0V	-	0.8	0.5	-	0.5	-	0.5		
$V_{IL}$	Low-Level Input Voltage	-	4.5V	-	2.1	1.35	-	1.35	_	1.35	V	
	input voltage	_	6.0V	_	2.8	1.8	_	1.8	_	1.8		
			2.0V	1.9	2.0	_	1.9	-	1.9	-		
	$I_{OH} = -20 \mu A$	I <sub>OH</sub> = -20 μA All outputs	4.5V	4.4	4.5	_	4.4	-	4.4	-		
Vон	High-Level Output Voltage	All outputs	6.0V	5.9	6.0	_	5.9	-	5.9	-	V	
	Output Voltage	$I_{OH} = -4 \text{ mA}$	4.5V	3.98	4.32	-	3.84	-	3.7	-		
		I <sub>OH</sub> = -5.2 mA	6.0V	5.48	5.81	-	5.34	-	5.2	-		
			2.0V	-	0	0.1	-	0.1	-	0.1		
				I <sub>OL</sub> = 20 μA All outputs	4.5V	_	0	0.1	_	0.1	_	0.1
$V_{OL}$	Low-Level Output Voltage	All outputs	6.0V	_	0	0.1	_	0.1	_	0.1	V	
	Output voltage	I <sub>OL</sub> = 4 mA	4.5V	=	0.15	0.26	=	0.33	=	0.4		
		I <sub>OL</sub> = 5.2 mA	6.0V	=	0.16	0.26	=	0.33	=	0.4		
lı	Input Current	V <sub>I</sub> =GND or 6.0V	6.0V	-	_	±0.1	=	± 1	-	± 1	μΑ	
I <sub>CC</sub>	Supply Current	$V_I = GND \text{ or } V_{CC}$ $I_O = 0$	6.0V	_	-	8.0	-	80	-	160	μΑ	
Ci	Input Capacitance	V <sub>i</sub> = V <sub>CC</sub> or GND	6.0V	_	4	10	-	10	_	10	pF	

# **Switching Characteristics**

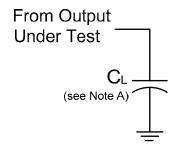
Symbol /	Pins	Test Conditions	Conditions V <sub>CC</sub>		A = +25°	С	-40°C to	+85°C	-40°C to +125°C		Unit
Parameter	FIIIS	rest Conditions	VCC .	Min	Тур	Max	Min	Max	Min	Max	Onit
			2.0V	_	41	150	-	190	-	225	
	A = 4 = <del>V</del> =	Figure 1	4.5V	-	15	30	-	38	_	45	
	An to $\overline{Y}$ n	rigule i	5.0V	-	12	_	-	ı	-	-	
			6.0V	-	12	26	-	33	-	38	
t <sub>PLH</sub> ,			2.0V	_	47	150	-	190	_	225	
t <sub>PLH</sub>	E3 to $\overline{Y}$ n	Figure 1	4.5V	_	17	30	-	38	-	45	ns
Propagation			5.0V	-	14	_	-	-	_	-	
Delay			6.0V	_	14	26	-	33	-	38	
		Figure 4	2.0V	_	47	150	-	190	-	225	
	En to Yn		4.5V	_	17	30	-	38	-	45	
	En to Yn	Figure 1	5.0V	_	14	_	-	-	-	_	
			6.0V	_	14	26	-	33	_	38	
t <sub>TLH,</sub>	₹n		2.0V	_	19	75	-	95	-	110	
t <sub>THL</sub>		Figure 1	5.0V	_	7	15	-	19	_	22	ns
Transition Time		, G	6.0V	-	6	13	=	16	=	19	



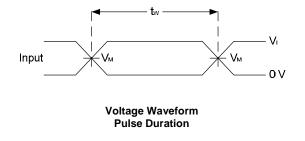
#### Operating Characteristics (@T<sub>A</sub> = +25°C, unless otherwise specified.)

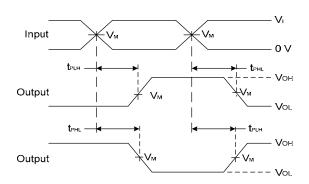
	Parameter	Test Conditions	V <sub>CC</sub> = 5V Typ	Unit
$C_{\sf pd}$	Power dissipation capacitance	f = 1 MHz all outputs switching-no load	19	pF

#### **Parameter Measurement Information**



Vee	Inj	outs	V	•	
Vcc	V <sub>1</sub>		V <sub>M</sub>	CL	
2.0V -6.0V	V <sub>CC</sub>	6 ns	V <sub>CC</sub> /2	50pF	
5.0V	Vcc	6 ns	V <sub>CC</sub> /2	15pF used for 5V typical test	





Voltage Waveform Propagation Delay Times **Inverting and Non Inverting Outputs** 

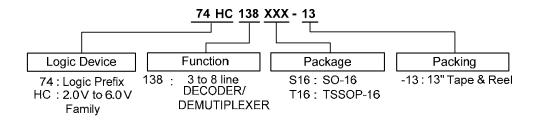
A. Includes test lead and test apparatus capacitance.

- B. All pulses are supplied at pulse repetition rate ≤ 10 MHz.
  C. Inputs are measured separately one transition per measurement
- D.  $t_{PLH}$  and  $t_{PHL}$  are the same as  $t_{PD}$

Figure 1 Load Circuit and Voltage Waveforms



## **Ordering Information**

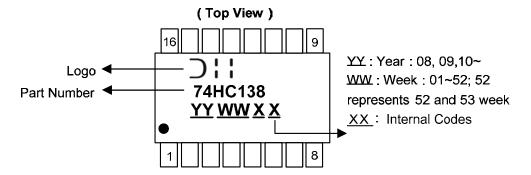


Part Number	Package Code Packaging		7" Tape an	nd Reel (Note 6)
Fait Number	Fackage Code	Fackaging	Quantity	Part Number Suffix
74HC138S16-13	S16	SO-16	2500/Tape & Reel	-13
74HC138T16-13	T16	TSSOP-16	2500/Tape & Reel	-13

Notes: 6. The taping orientation is located on our website at http://www.diodes.com/datasheets/ap02007.pdf

### **Marking Information**

#### (1) SO-16, TSSOP16



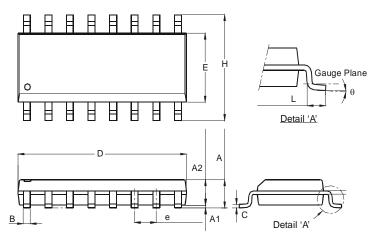
Part Number	Package
74HC138S16	SO-16
74HC138T16	TSSOP-16



# Package Outline Dimensions (All dimensions in mm.)

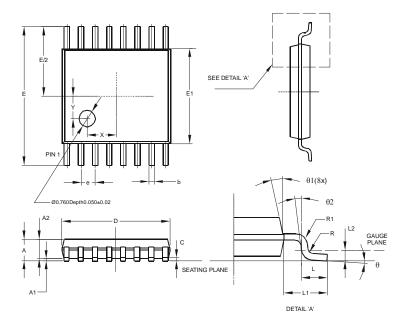
Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for latest version.

#### Package Type: SO-16



	SO-16					
Dim	Min	Max				
Α	1.40	1.75				
A1	0.10	0.25				
A2	1.30	1.50				
В	0.33	0.51				
С	0.19	0.25				
D	9.80	10.00				
Е	3.80	4.00				
е	1.27	Тур				
H	5.80	6.20				
L	0.38	1.27				
Θ	0°	8°				
All Dimensions in mm						

#### Package Type: TSSOP-16



	TSS	OP-16	i				
Dim	Min	Max	Тур				
Α	-	1.08	-				
<b>A</b> 1	0.05	0.15	-				
A2	0.80	0.93	-				
p	0.19	0.30	-				
С	0.09	0.20	-				
D	4.90	5.10	-				
Е	6	.40 BS	SC Sc				
E1	4.30	4.50	-				
е	C	.65 BS	SC SC				
٦	0.45	0.75	-				
L1	1	.00 R	EF				
L2	0	.25 BS	SC				
R	0.09	ı	-				
R1	0.09	ı	-				
X	-	1	1.350				
Υ	-	-	1.050				
Θ	0°	8°	-				
Θ1	5°	15°	-				
Θ2	0°	-	-				
All Dimensions in mm							

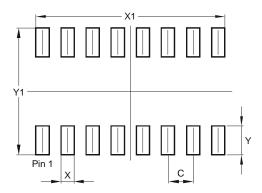
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# **Suggested Pad Layout**

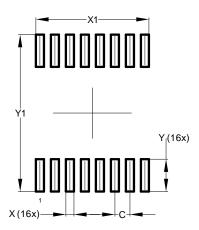
Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.

#### Package Type: SO-16



Dimensions	Value (in mm)
С	1.270
Х	0.670
X1	9.560
Y	1.450
Y1	6.400

#### Package Type: TSSOP-16



Dimensions	Value (in mm)
С	0.650
Х	0.350
X1	4.900
Υ	1.400
Y1	6.800



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